

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

	PRODUC	1/PKC	ICESS CE	IANG	F NO	TICE (PC	IN)
PCN #: <b>A1804-01</b> DATE: <b>18-Apr-2018</b>			MEANS OF DISTINGUISHING CHANGED DEVICES:				
Product Affected	TSE2004GB2C0N TSE2004GB2C0N			☐ Produc ☐ Back M ☐ Date C ■ Other	Mark	Assembly lot# "TF" denote T "HT" denote F	FME, China
Date Effective:	18-Jul-2018						
Contact: E-mail:	IDT PCN DESK pcndesk@idt.com			Attachment Samples:	•	•	☐ No I sales representative for
DESCRIPTION	AND PURPOSE OF O	CHANGE:					
<ul><li>□ Wafer Fabrica</li><li>□ Assembly Pro</li><li>□ Equipment</li><li>□ Material</li><li>□ Testing</li></ul>	□ Die Technology □ Wafer Fabrication Process □ Assembly Process □ Equipment □ Material □ Testing □ Manufacturing Site □ Data Sheet □ Data Sheet □ Data Sheet □ This notification is to advise our customers that IDT is adding TFME, China and HTC, China as alternate facilities for Assembly, Test and Backend process for the select product. Current Assembly, Test and Backend location is Carsem, Malaysia.  Attachment 1 details the change.						
	QUALIFICATION SU ected change to the proc			rformance.			
CUSTOMER A	CKNOWLEDGMENT	Γ OF REC	EIPT:				
to grant approval it will be assume IDT reserves the	icate that you require will or request additional in the change is acceptable to ship either versus on has been depleted.	nformation ceptable. sion manufa	. If IDT does not	receive acl	knowledge	ement within 30	days of this notice
Customer:			⊏	] Appro	oval for s	shipments pr	rior to effective date.
Name/Date:			E-	-Mail Addr	ess:		
Title: Phone# /Fax# :							
CUSTOMER COMMENTS:							
IDT ACKNOW	LEDGMENT OF REC	CEIPT:					
RECD. BY:				DATE:			

#### **ATTACHMENT 1 - PCN # : A1804-01**

**PCN Type:** Manufacturing Site - Alternate Assembly, Test & Backend Location

**Data Sheet Change:** None

**Detail Of Change:** 

This notification is to advise our customers that IDT is adding TFME, China and HTC, China as alternate facilities for Assembly, Test and Backend process for the select product. Current Assembly, Test and Backend location is Carsem, Malaysia.

This change will allow IDT the flexibility to ship from all the qualified facilities and will provide the increased capacity, flexibility and shorter lead time to meet market demand.

The material set details of the current and alternate assembly locations are as shown in Table 1.

There is no change to moisture sensitive level.

There is no change in the Test processing flows. IDT has completed the electrical test correlation and based on the test results we do not anticipate any impact on device performance. The testing is fully compatible and transferrable between the test facilities with no change to the test coverage.

The Backend process is standardized between the alternate sites. The carrier tape and plastic reel used in the alternate sites are with the same dimensions as used in Carsem Malaysia. There is no change to form, fit and functions.

If you require samples to conduct evaluations, please contact your local sales representative to acknowledge this PCN and request samples.

Table 1: Assembly Material Sets for The Existing and Alternate Assembly Locations

	Existing Assembly (Carsem, Malaysia)	Alternate Assembly (TFME, China)	Alternate Assembly (HTC, China)
Die Attach	EN4900GC	EN4900GC	8200T
Bond Wire	Gold wire	Gold wire	Gold wire
Mold Compound	CEL-9240HF10CS	CEL-9240HF10NF-B3	CEL-9240HF10NF-B3
Singulation Method	Sawn	Sawn	Sawn

#### **ATTACHMENT 1 - PCN # : A1804-01**

# **Qualification Information and Qualification Data: Assembly Qualification Results**

**Affected Packages:** VFQFPN-8

**Assembly Material:** Shown on page 2 of this attachment.

**Qual Plan & Results:** Tests are in accordance with JEDEC47 recommended tests.

**Qualification Vehicle:** VFQFPN-8, 3 lots each Assembly Location

		Test Resu	lts (Rej / SS)
Test Description	Test Method	TFME, China	HTC, China
* Temperature Cycling (-55°C to 125°C, 700 cycles)	JESD22-A104	0/25, 0/25, 0/25	0/25, 0/25, 0/25
* HAST - biased (130 °C/85% RH, 96 Hrs)	JESD22-A110	0/25, 0/25, 0/25	0/25, 0/25, 0/25
High Temperature Storage Bake (150°C, 1000 Hrs)	JESD22-A103	0/25, 0/25, 0/25	0/25, 0/25, 0/25
Ball Shear Test	JESD22-B116	0/5, 0/5, 0/5	0/5, 0/5, 0/5
Bond Pull Test	IDT Spec MAC- 3010	0/5, 0/5, 0/5	0/5, 0/5, 0/5
X Ray	IDT Spec. MAC-3012	0/45, 0/45, 0/45	0/45, 0/45, 0/45
Moisture Sensitivity Level, MSL	J-STD-20 / MSL 1, 260 °C	0/25, 0/25	0/25, 0/25

<sup>\*</sup> Tests were subjected to Preconditioning per JESD22-A113 prior to stress test

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# PRODUCT/PROCESS CHANGE NOTICE (PCN)

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#### **Electrical Test Correlation Results**

**Vehicle:** TSE2004GB2C0

**Sample size:** 600 electrically good units and 30 GRR units for each Test Location

Description	Existing Test (Carsem, Malaysia)	Alternate Test (TFME, China)	Alternate Test (HTC, China)
Tester Platform	HP83000	Nextest maverick PT2	Verigy v50
Loadboard	SN#1	SN#1	SN#1
Test Program	QC_Cruz_TF	QC_Cruz_TF	QC_Cruz_TF
Test Site	4	4	2
Test Temperature	25°C	25°C	25°C
Test Correlation Results	100%	100%	100%
Number of Good Units Correlated @ ambient	600 pcs	600 pcs	600 pcs
600 units Bin 1 handler run (good units)	Passed	Passed	Passed
Number of GRR Units Correlated @ ambient	N/A	30 pcs	30 pcs
30 units GRR handler run by site	N/A	Passed	Passed
600 units Bin 1 datalog correlation (good units)	Passed	Passed	Passed



#### **ATTACHMENT 1 - PCN #: A1804-01**

#### **Carrier Tape and Plastic Reel comparisons (Carsem and TFME, China)**

<u>Table 1:</u> Carrier Tape Comparisons

	Carsem, Malaysia	TFME, China
Part Number	C-PAK BD0200x0300	ECA1941-PS-BLK-520
Ao	2.3+-0.1mm	2.3+-0.05mm
Во	3.2+-0.1mm	3.2+-0.05mm
Ko	1.0+-0.1mm	1.0+-0.05mm
P	4.0+-0.1mm	4.0+-0.1mm
W	8.0+-0.3mm	8.0+-0.2/-0.1mm
Drawing	Refer Page 7	Refer Page 8
Snapshot	E E E E E E E E E	ก่อก่อก่อก่อก่อก่อก

Table 2: Plastic Reel Comparisons

Part Number	Carsem, Malaysia NEWTECH P9-065-000 White	TFME, China E-PAK eRL0126-T08-A47-TRL 7"
Reel Dia	2"	2"
Hub Dia		
Drawing	Refer Page 9, 10	Refer Page 11
Snapshot		



#### **ATTACHMENT 1 - PCN #: A1804-01**

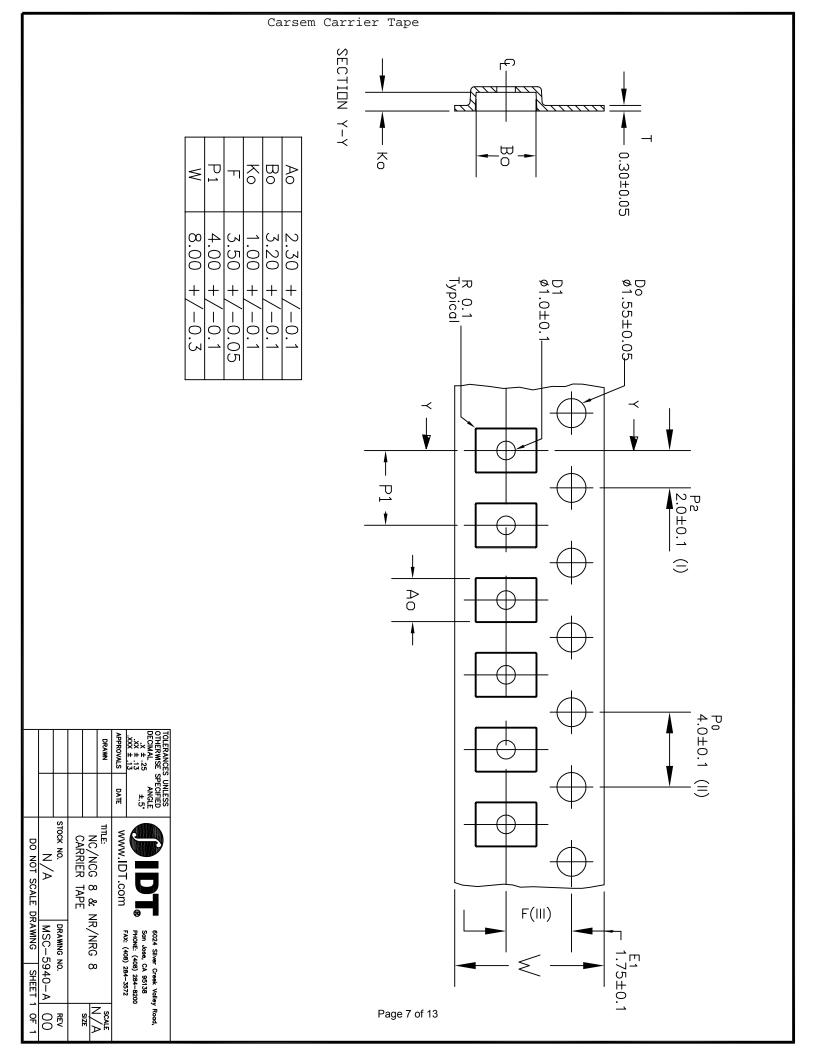
#### Carrier Tape and Plastic Reel comparisons (Carsem and HTC, China)

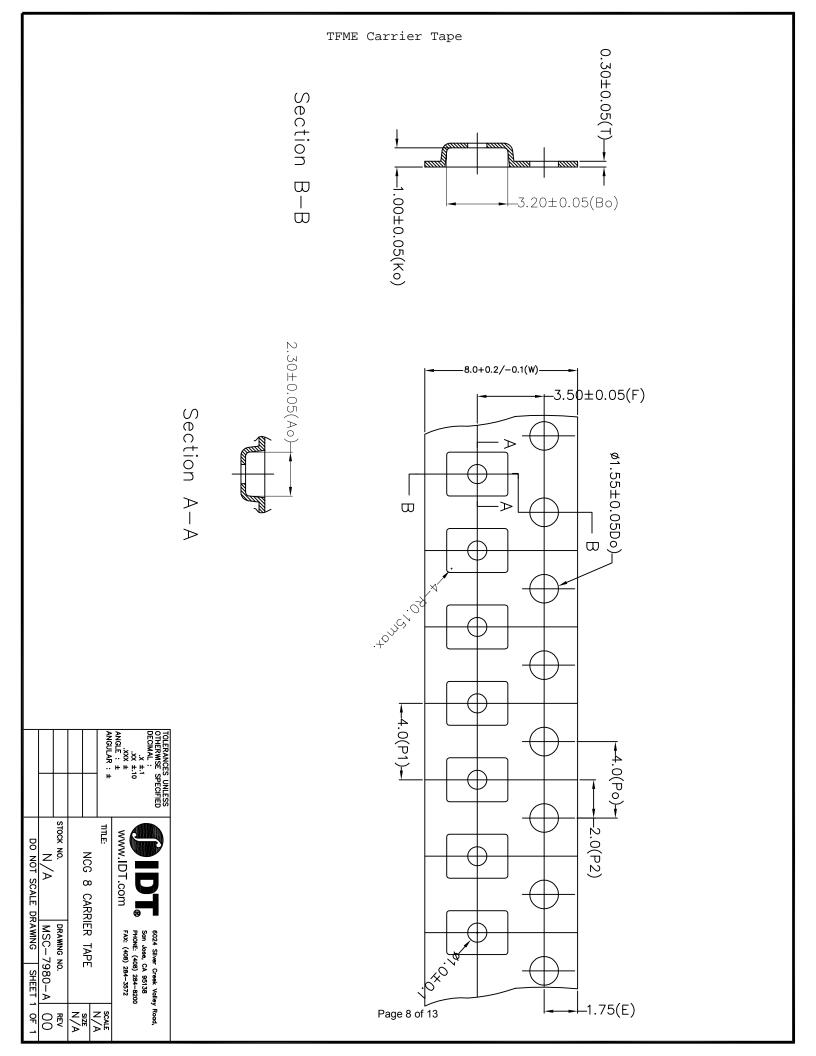
<u>Table 3:</u> Carrier Tape Comparisons

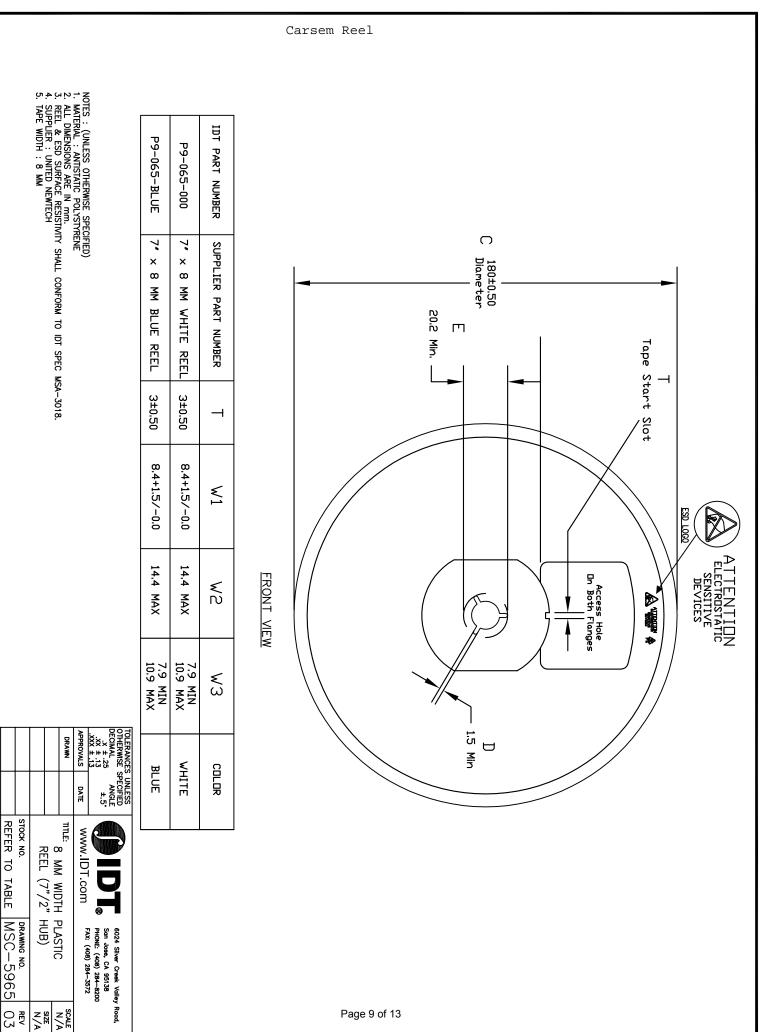
	Carsem, Malaysia	HTC, China
Part Number	C-PAK BD0200x0300	ECA1941-PS-BLK-520
Ao	2.3+-0.1mm	2.3+-0.05mm
Во	3.2+-0.1mm	3.2+-0.05mm
Ko	1.0+-0.1mm	1.0+-0.05mm
P	4.0+-0.1mm	4.0+-0.1mm
W	8.0+-0.3mm	8.0+-0.2/-0.1mm
Drawing	Refer Page 7	Refer Page 12
Snapshot		ग्रांग्रांग्रांग्रांग्रांग्रांग्रांग्रां

Table 4: Plastic Reel Comparisons

Part Number	Carsem, Malaysia NEWTECH P9-065-000 White	HTC, China E-PAK eRL0126-T08-A47-TRL
Reel Dia	7"	7"
Hub Dia	2"	2"
Drawing	Refer Page 9, 10	Refer Page 13
Snapshot		







DO NOT SCALE DRAWING

SHEET 1

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